

Low Voltage, Low On-Resistance, Dual DPDT Analog Switch

DESCRIPTION

The DG2799 is a dual double-pole/double-throw monolithic CMOS analog switch designed for high performance switching of analog signals. Combining low power, high speed, low on-resistance and small physical size, the DG2799 is ideal for portable and battery powered applications requiring high performance and efficient use of board space.

The DG2799 is built on Vishay Siliconix's low voltage process. An epitaxial layer prevents latchup. Break-beforemake is guaranteed.

The switch conducts equally well in both directions when on, and blocks up to the power supply level when off.

As a committed partner to the community and the environment, Vishay Siliconix manufactures this product with the lead (Pb)-free device terminations. For analog switching products manufactured in QFN packages, the lead (Pb)-free "-E3/E4" only suffix is being used as a designator. Lead (Pb)-free QFN products purchased at any time will have either a nickel-palladium-gold device termination or a 100 % matte tin device termination. The different lead (Pb)-free materials are interchangeable and meet all JEDEC standards for reflow and MSL rating.

FEATURES

- Low Voltage Operation (1.65 V to 4.3 V)
- Low On-Resistance r_{ON}: 0.25 Ω @ 2.7 V
- Fast Switching: t_{ON} = 28 ns t_{OFF} = 17 ns
- QFN-16 (3 x 3) Package
- Latch-Up Current > 300 mA (JESD78)

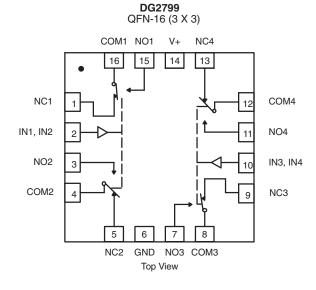
BENEFITS

- Reduced Power Consumption
- · High Accuracy
- Reduce Board Space
- TTL/1.8-V Logic Compatible
- · High Bandwidth

APPLICATIONS

- Cellular Phones
- · Speaker Headset Switching
- · Audio and Video Signal Routing
- PCMCIA Cards
- · Battery Operated Systems

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION



TRUTH TABLE							
Logic	NC1, 2, 3 and 4	NO1, 2, 3 and 4					
0	ON	OFF					
1	OFF	ON					

ORDERING INFORMATION					
Temp Range	Package	Part Number			
–40 to 85°C	16-Pin QFN (3 x 3 mm) Variation 2	DG2799DN-T1—E4			

NOTE:

Underside exposed pad has no device electrical connection. It is recommended that no electrical connection is made to it.



ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted							
Paramete	Symbol	Limit	Unit				
Reference to GND	V+		-0.3 to 5.0	V			
helerence to GND	IN, COM, NC, NO ^a		-0.3 to (V+ + 0.3)	v			
Current (Any terminal except NO, NC or		30					
Continuous Current (NO, NC, or COM)		±300	mA				
Peak Current (Pulsed at 1 ms, 10 % duty		±500					
Storage Temperature (D Suffix)			-65 to 150	°C			
Package Solder Reflow Conditions ^d	16-Pin QFN (3 x 3 mm)	x 3 mm) 250					
Power Dissipation (Packages) ^b	QFN-16 ^c		1385	mW			

Notes

- a. Signals on NC, NO, or COM or IN exceeding V+ will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
- b. All leads welded or soldered to PC Board.
- c. Derate 17.3 mW/°C above 70°C
- d. Manual soldering with iron is not recommended for leadless components. The QFN is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper lip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

SPECIFICATIONS (V+ = 1.8 \	V)					
		Test Condition Otherwise Unless Specified		Limits -40 to 85°C			
Parameter	Symbol	$V+ = 1.8 \text{ V}, V_{IN} = 0.4 \text{ or } 1.1 \text{ V}^{e}$	Temp ^a	Min ^b	Typ ^c	Max ^b	Unit
Analog Switch	JI.					1	
Analog Signal Range ^d	V_{NO}, V_{NC}, V_{COM}		Full	0		V+	V
		$V+ = 1.8 \text{ V}, V_{COM} = 0.2 \text{ V}, I_{NO}, I_{NC} = 100 \text{ mA}$	Room		0.35	1.3	
On-Resistance	r _{ON}	$V+ = 1.8 \text{ V}, V_{COM} = 0.9 \text{ V}, I_{NO}, I_{NC} = 100 \text{ mA}$	HOOIII		0.45	1.3	Ω
			Full			1.4	
Digital Control							
Input High Voltage	V_{INH}		Full	1.1			V
Input Low Voltage	V_{INL}		Full			0.4	ľ
Input Capacitance	C _{in}		Full		6		pF
Input Current	I _{INL} or I _{INH}	V _{IN} = 0 or V+	Full	-1		1	μΑ
Dynamic Characteristics	JI.					· I	
Turn-On Time	t _{ON}	V_{NO} or V_{NC} = 1.5 V, R_L = 50 Ω , C_L = 35 pF	Romm Full		62	94 97	
Turn-Off Time	t _{OFF}		Room Full		24	52 55	ns
Break-Before-Make Time	t _d		Full	8			
Charge Injection ^d	Q_{INJ}	$C_L = 1$ nF, $V_{GEN} = 0$ V, $R_{GEN} = 0$ Ω	Room		66		рC
Off-Isolation ^d	OIRR	D 500 0 5 5 4 400 H	Room		-74		
Crosstalk ^d	X _{TALK}	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 100 kHz$	Room		-74		dB
o d	C _{NO(off)}	V _{IN} = 0 or V+, f = 1 MHz	Room		108		
N _O , N _C Off Capacitance ^d	C _{NC(off)}		Room		108		_
Channel-On Capacitance ^d	C _{NO(on)}		Room		240		pF
	C _{NC(on)}		Room		240		
Power Supply	. ,		1			1	ı
Power Supply Current	l+	$V_{IN} = 0$ or V+	Full			1.0	μΑ





		Test Condition Otherwise Unless Specified		Limits -40 to 85°C			
Parameter	Symbol	$V+ = 3 V, \pm 10 \%, V_{IN} = 0.5 \text{ or } 1.4 V^{e}$	Temp ^a	Min ^b	Typ ^c	Max ^b	Unit
Analog Switch					•		
Analog Signal Range ^d	V_{NO}, V_{NC}, V_{COM}		Full	0		V+	V
		$V+ = 2.7 \text{ V}, V_{COM} = 0.2 \text{ V}, I_{NO}, I_{NC} = 100 \text{ mA}$			0.3	0.45	
On-Resistance	r _{ON}	$V+ = 2.7 \text{ V}, V_{COM} = 1.5 \text{ V}, I_{NO}, I_{NC} = 100 \text{ mA}$	Room		0.25	0.45	
			Full			0.55	
r _{ON} Flatness ^d	r _{ON} Flatness	$V+ = 2.7 \text{ V}, V_{COM} = 0 \text{ to } V+,$	Room		0.07	0.15	Ω
r _{ON} Match ^d	Δr _{ON}	I _{NO} , I _{NC} = 100 mA	Room		0.05		
	I _{NO(off)} , I _{NC(offF)}	$V+ = 3.3 \text{ V}, V_{NO}, V_{NC} = 0.3 \text{ V} / 3.0 \text{ V},$	Room Full	-1 -10		1 10	
Switch Off Leakage Current	I _{COM(off)}	$V_{COM} = 3.0 \text{ V} / 0.3 \text{ V}$	Room	-1		1	nA
Channel On Lealing	OOM(on)		Full	-10		10	
Channel-On Leakage Current	I _{COM(on)}	$V + = 3.3 \text{ V}, V_{NO}, V_{NC} = V_{COM} = 0.3 \text{ V} / 3.0 \text{ V}$	Room Full	−1 −10		1 10	
Digital Control					•		•
Input High Voltage	V_{INH}		Full	1.4			V
Input Low Voltage	V_{INL}		Full			0.5	v
Input Capacitance	C_in		Full		6		pF
Input Current	$I_{\rm INL}$ or $I_{\rm INH}$	$V_{IN} = 0$ or V+	Full	-1		1	μΑ
Dynamic Characteristics							
Turn-On Time	t _{ON}		Romm Full		28	57 60	
Turn-Off Time	t _{OFF}	V_{NO} or V_{NC} = 1.5 V, R_L = 50 Ω , C_L = 35 pF	Room Full		17	45 47	ns
Break-Before-Make Time	t _d		Full	1			
Charge Injection ^d	Q _{INJ}	$C_L = 1 \text{ nF, } V_{GEN} = 0 \text{ V, } R_{GEN} = 0 \Omega$	Room		160		рС
Off-Isolation ^d	OIRR	D 50.0 0 5 5 6 400 Hz	Room		-75		
Crosstalk ^d	X _{TALK}	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 100 kHz$	Room		-75		dB
N _O , N _C Off Capacitance ^d	C _{NO(off)}	V _{IN} = 0 or V+, f = 1 MHz	Room		102		pF
140, 14C On Oapacitance	C _{NC(off)}		Room		102		
Channel-On Capacitance ^d	C _{NO(on)}	- III	Room		234		
опаппеноп бараспапсе	C _{NC(on)}		Room		234		
Power Supply							
Power Supply Range	V+			2.7		3.3	V
Power Supply Current	I+	V _{IN} = 0 or V+	Full			1.0	μΑ



SPECIFICATIONS (V+ = 4.3	V)					
		Test Condition Otherwise Unless Specified		Limits -40 to 85°C		;	
Parameter	Symbol	$V+ = 4.3 \text{ V}, V_{1N} = 0.5 \text{ or } 1.6 \text{ V}^{e}$	Temp ^a	Min ^b	Typ ^c	Max ^b	Unit
Analog Switch					•	•	•
Analog Signal Range ^d	V_{NO}, V_{NC}, V_{COM}		Full	0		V+	V
		$V+ = 4.3 \text{ V}, V_{COM} = 0.5 \text{ V}, I_{NO}, I_{NC} = 100 \text{ mA}$	Doom		0.29	0.40	
On-Resistance	r _{ON}	$V+ = 4.3 \text{ V}, V_{COM} = 2.1 \text{ V}, I_{NO}, I_{NC} = 100 \text{ mA}$	Room		0.21	0.43	
			Full			0.53	
r _{ON} Flatness ^d	r _{ON} Flatness	$V+ = 4.3 \text{ V}, V_{COM} = 0 \text{ to } V+,$	Room		0.07	0.15	Ω
r _{ON} Match ^d	∆r _{ON}	I_{NO} , $I_{NC} = 100 \text{ mA}$	Room		0.05		
Switch Off Leakage	I _{NO(off)} , I _{NC(offF)}	$V+ = 4.3 \text{ V}, V_{NO}, V_{NC} = 0.3 \text{ V} / 4.0 \text{ V},$	Room -10 0.3 V / 4.0 V, Full -100		10 100		
Current ^d	I _{COM(off)}	V _{COM} = 4.0 V / 0.3 V	Room Full	-10 -100		10 100	nA
Channel-On Leakage Current ^d	I _{COM(on)}	$V+ = 4.3 \text{ V}, V_{NO}, V_{NC} = V_{COM} = 3.0 \text{ V} / 4.0 \text{ V}$	Room Full	−10 −100		10 100	
Digital Control							
Input High Voltage	V _{INH}		Full	1.6			V
Input Low Voltage	V_{INL}		Full			0.5	v
Input Capacitance	C _{in}		Full		6		pF
Input Current	I _{INL} or I _{INH}	V _{IN} = 0 or V+	Full	-1		1	μΑ
Dynamic Characteristics					•	•	•
Charge Injection ^d	Q_{INJ}	C_L = 1 nF, V_{GEN} = 0 V, R_{GEN} = 0 Ω	Room		320		рC
Off-Isolation ^d	OIRR	D = 50 0 C = 5 5 5 = 100 kHz	Room		-73		٩D
Crosstalk ^d	X _{TALK}	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 100 kHz$	Room		-73		dB
N. N. Off Canacitanaed	C _{NO(off)}		Room		100		
N _O , N _C Off Capacitance ^d	C _{NC(off)}	V _{IN} = 0 or V+, f = 1 MHz	Room		100		"F
Channel-On Capacitance ^d	C _{NO(on)}	V _{IN} = 0 01 V+, 1 = 1 IVI⊓Z	Room		230		- pF -
	C _{NC(on)}		Room		230		
Power Supply	•		•		•	•	•
Power Supply Range	V+					4.3	V
Power Supply Current	l+	$V_{IN} = 0$ or $V+$	Full			1.0	μΑ

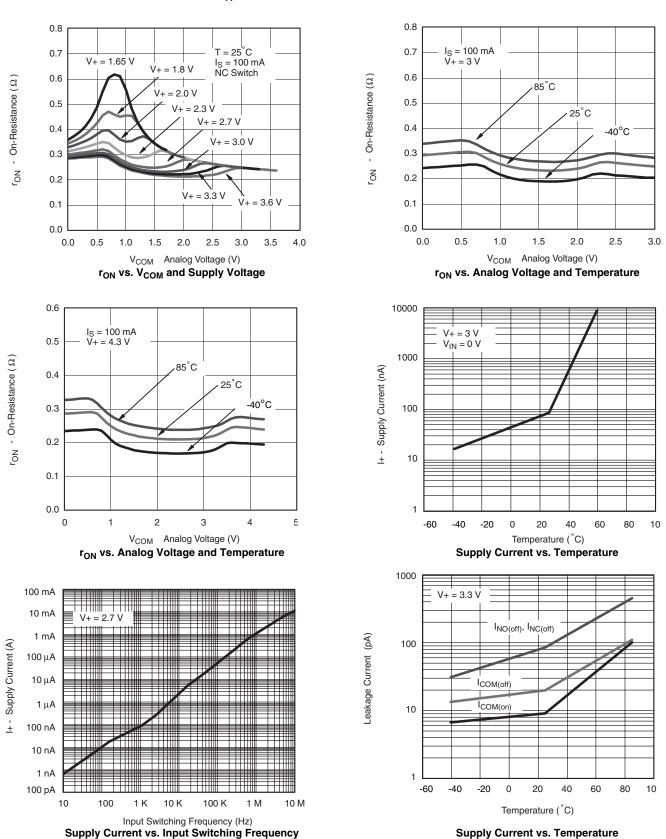
Notes

- a. Room = 25° C, Full = as determined by the operating suffix.
- b. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
- c. Typical values are for design aid only, not guaranteed nor subject to production testing.
- d. Guarantee by design, not subjected to production test.
- e. V_{IN} = input voltage to perform proper function.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

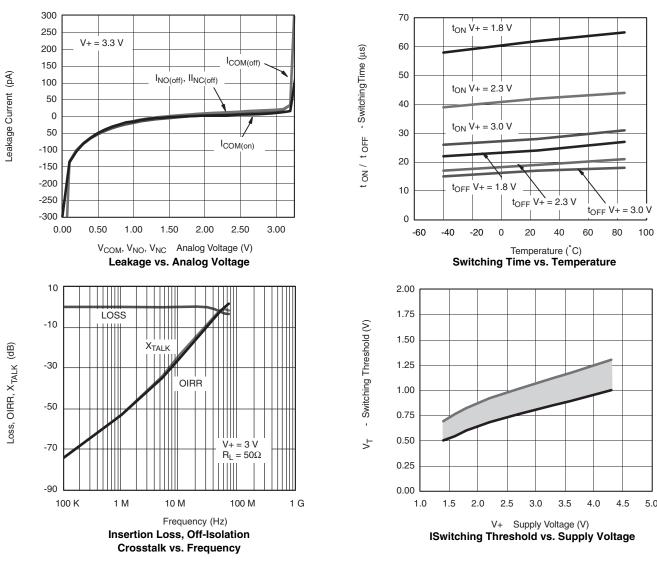


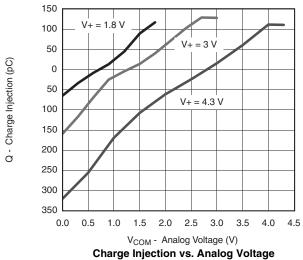
TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted



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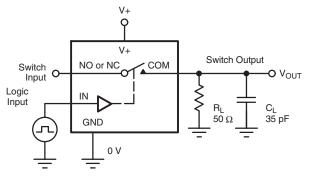
TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted





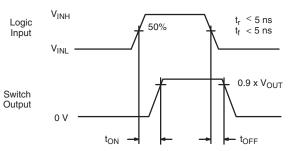


TEST CIRCUITS



C_L (includes fixture and stray capacitance)

$$V_{OUT} = V_{COM} \left(\frac{R_L}{R_L + R_{ON}} \right)$$



Logic "1" = Switch On Logic input waveforms inverted for switches that have the opposite logic sense.

Figure 1. Switching Time

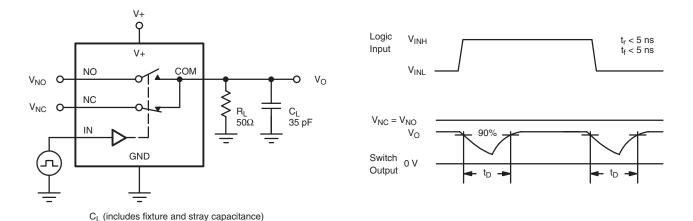


Figure 2. Break-Before-Make Interval

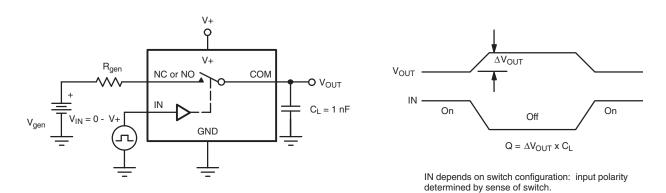


Figure 3. Charge Injection

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TEST CIRCUITS

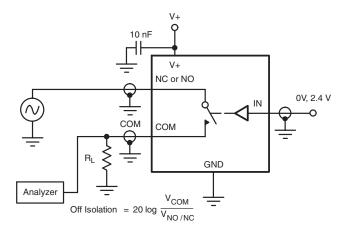


Figure 4. Off-Isolation

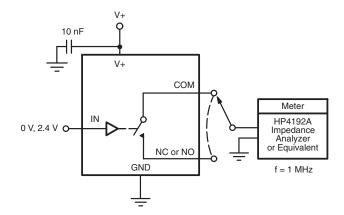


Figure 5. Channel Off/On Capacitance

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